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Name of conveying party	y(ies):	Name and address of receiving party(ies)	86 ا
JEONG, Jun-Ho SIM, Young-Suk KIM, Ki-Don Additional name(s) of conveying pa	CHOI, Dae-Geun LEE, Eung-Sug arty(ies) attached? □Yes ☑No	Name: KOREA INSTITUTE OF MACHINERY & MATERIALS Internal Address:	
3. Nature of conveyance:			
	☐ Merger	Street Address: 171, Jang-dong, Youscong-ku	
☐ Security Agreement	☐ Change of Name		
☐ Other		City: Daejeon-city State: Republic Zip: 305-343 of Korea	
Octobe	er 2, 2006; October 2, 2006; er 2, 2006; October 2, 2006; er 2, 2006;	Additional name(s) & address(es) attached? ☐ Yes ☑ No	
4. Application number(s) or	r patent number(s):		
		October 18, 2006	
A. Patent Application No	o.(s)	B. Patent No.(s)	
	Additional number	s attached? ☐ Yes ⊠ No	
A. Patent Application No. S. Name and address of part concerning document should be a second address.	Additional number y to whom correspondence		
Name and address of part	Additional number y to whom correspondence uld be mailed:	s attached? ☐ Yes ⊠ No	
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Name and address of particular concerning document shot Name: Pearl Collen Ze	Additional number y to whom correspondence uld be mailed:	s attached? Yes No 6. Total number of applications and patents involved: 7. Total fee (37 CFR3.41)	
5. Name and address of particonceming document shot Name: Pearl Cohen Ze Internal Address: Street Address: 15	Additional number y to whom correspondence uld be mailed:	s attached? Yes No 6. Total number of applications and patents involved: 7. Total fee (37 CFR3.41)\$ 40.00 Enclosed	
5. Name and address of particonceming document short Name: Pearl Collen Zellnternal Address: Street Address: 15	Additional number y to whom correspondence uld be mailed: edek Latzer, LLP	s attached? Yes No 6. Total number of applications and patents involved: 7. Total fee (37 CFR3.41)	
5. Name and address of particonceming document short Name: Pearl Collen Zenternal Address: Street Address: 15	Additional number by to whom correspondence uld be mailed: edek Latzer, LLP 500 Broadway The Floor tate: NY Zip: 10036	s attached? Yes No 6. Total number of applications and patents involved: 7. Total fee (37 CFR3.41)	

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231

Docket	No.:		

ASSIGNMENT

In consideration of One Dollar (\$1.00), and other good and valuable consideration, the Receipt of which is hereby acknowledged, I the undersigned, JEONG, Jun-Ho residing at 411-1602, Yeolmae maeul, 858bunji, Jijok-dong, Youseong-ku, Daejeon-city, 305-330, Republic of Korea; SIM, Young-Suk residing at 251-18bunji, Guui 1-dong, Kwangjin-ku, Seoul, 143-201, Republic of Korea; KIM, Ki-Don residing at 9-110, Miseong Apt., 17-6bunji, Sincheon-dong, Songpa-ku, Seoul, 138-240, Republic of Korea; CHOI, Dae-Geun residing at 126-20bunji, Sinseong-dong, Yuseong-ku, Daejeon-city, 305-805, Republic of Korea; LEE, Eung-Sug residing at 171bunji, Jang-dong, Youseong-ku, Daejeon-city, 305-343, Republic of Korea.

Hereby sell, assign and transfer to KOREA INSTITUTE OF MACHINERY & MATERIALS, located at 171, Jang-dong, Youseong-ku, Daejeon-city, 305-343, Republic of Korea, its successors, assigns and legal representatives (hereinafter, the "Assignee"), the entire right, title and interest for all countries, in and to any and all inventions which are disclosed and claimed, and as possessed by the undersigned, any and all inventions which are disclosed but not claimed in the application for United States Application No.

filed is entitled

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and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for U.S. Letters Patent or other related property rights in any and all foreign countries which have been or shall be filed on any of said inventions disclosed in said application; and in and to all original and reissued patents or related foreign documents which have been or shall be issued on said inventions;

Authorize and request the Commissioner of Patents of the United States to issue to said Assignee, the corporation above named, its successors, assigns and legal representatives, in accordance with this assignment, any and all United States Letters Patent on said inventions or any of them disclosed in said application;

Agree that said Assignee may apply for and receive foreign Letters Patent or rights of any other kind for said inventions, or any of them; and may claim, in applications for said foreign Letters Patent or other rights, the priority of the aforesaid United States patent application under the provisions of the International Convention of 1883 and later modifications thereof, under the Patent

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Cooperation Treaty, under the European Patent Convention or under any other available international agreement; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the under-signed or the undersigned's executors or administrators will, for the United States and all foreign countries, execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications or other documents on any and all said inventions; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns and representatives, all facts known and documents available to the undersigned relating to said inventions and the history thereof; testify in all legal proceedings; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said inventions and for vesting title to said inventions and all applications for patents or related foreign rights and all patents on said inventions, in said Assignee, its successors, assigns and legal representatives; and

COVENANT with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

FULL NAME OF INVENTOR: JEONG, Jun-Ho	FULL NAME OF WITNESS: KIM, Young-Ju
SIGNATURE OF INVENTOR:	SIGNATURE OF WITNESS:
DATE: 2/10/2006 (day / month / year)	ADDRESS OF WITNESS: 102-701, Hyundai Apt., Shinsu-dong, Mapo-ku, Seoul, 121-050, Korea

FULL NAME OF INVENTOR: SIM, Young-Suk	FULL NAME OF WITNESS: KIM, Young-Ju
SIGNATURE OF INVENTOR:	SIGNATURE OF WITNESS:
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DATE: 2 / 10/2006 (day / month / year)	ADDRESS OF WITNESS: 102-701, Hyundai Apt., Shinsu-dong, Mapo-ku, Seoul, 121-050, Korea

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FULL NAME OF INVENTOR: KIM, Ki-Don	FULL NAME OF WITNESS: KIM, Young-Ju
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FULL NAME OF INVENTOR: CHOI, Dae-Geun	FULL NAME OF WITNESS: KIM, Young-Ju
SIGNATURE OF INVENTOR:	SIGNATURE OF WITNESS:
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FULL NAME OF INVENTOR: LEE, Eung-Sug	FULL NAME OF WITNESS: KIM, Young-Ju	
SIGNATURE OF INVENTOR:	SIGNATURE OF WITNESS:	
0/-6/2	tri yongju	
DATE: 2/10/2006 (day / month / year)	ADDRESS OF WITNESS: 102-701, Hyundai Apt., Shinsu-dong, Mapo-ku, Seoul, 121-050, Korea	

RECORDED: 10/18/2006